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Part Number: [0736443000](#)
Status: **Active**
Overview: [hdm](#)
Description: 2.00mm (.079") Pitch HDM® Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location B, Polarizing Key Position A, 144 Circuits

Documents:
[3D Model](#)
[Test Summary \(PDF\)](#)
[Drawing \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
UL E29179

General

Product Family Backplane Connectors
Series [73644](#)
Application Backplane
Comments Standard Press-Fit, Tin/Lead (SnPb)
Component Type PCB Header
Overview [hdm](#)
Product Name HDM®
Style N/A

Physical

Circuits (Loaded) 144
Circuits (maximum) 144
Color - Resin Black, Natural
Durability (mating cycles max) 250
First Mate / Last Break No
Flammability 94V-0
Guide to Mating Part Yes
Keying to Mating Part Yes
Material - Metal Phosphor Bronze, Stainless Steel
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Number of Columns 24
Number of Pairs Open Pin Field
Number of Rows 6
Orientation Vertical
PC Tail Length (in) 0.138 In
PC Tail Length (mm) 3.50 mm
PCB Locator No
PCB Retention Yes
PCB Thickness Recommended (in) 0.098 In
PCB Thickness Recommended (mm) 2.50 mm
Packaging Type Tube
Pitch - Mating Interface (in) 0.079 In
Pitch - Mating Interface (mm) 2.00 mm
Pitch - Term. Interface (in) 0.079 In
Pitch - Term. Interface (mm) 2.00 mm
Plating min: Mating (µin) 30
Plating min: Mating (µm) 0.75
Plating min: Termination (µin) 15
Plating min: Termination (µm) 0.375



image - Reference only

Series

EU RoHS
RoHS Compliant by Exemption
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS

Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[73644Series](#)

Mates With
[73632](#) HDM PLUS® Board-to-Board Daughtercard Receptacle. [73780](#) HDM® Board-to-Board Daughtercard Receptacle

Application Tooling FAQ	
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.	
Global	
Description	Product #
Flat Rock Tooling for	0622013700
Pneumatic Press	
HDM® Backplane	0621001400
Insertion Signal	
Contact Tool	
HDM® Backplane	0622005703
Insertion Head for	
144 Positions	

Polarized to PCB	No	Extraction Tool	0621001000
Stackable	No		
Surface Mount Compatible (SMC)	Yes		
Temperature Range - Operating	-55°C to +105°C		
Termination Interface: Style	Through Hole - Compliant Pin		
Electrical			
Current - Maximum per Contact	1A		
Data Rate	1.0 Gbps		
Real Signals (per 25mm)	75		
Shielded	No		
Voltage - Maximum	250V AC		
Material Info			
Reference - Drawing Numbers			
Packaging Specification	PK-70873-0818		
Sales Drawing	SDA-73644-****		

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1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK, TERMINAL - PHOSPHOR BRONZE.

2. FINISHES: SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MINIMUM THICKNESS; NICKEL (Ni) AND GOLD FLASH OVERALL SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MIN. THICKNESS; SELECTIVE TIN/LEAD (Sb/Pb) IN TAIL AREA; NICKEL (Ni) OVERALL.

3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73670-9999.

4. FOR MIXED CONTACT MATING LENGTHS, CONSULT FACTORY FOR AVAILABILITY.

5. DIMENSIONS ARE IN MILLIMETERS.

6. FOR SPECIFIC MATERIAL NUMBERS, REFER TO SHEET 2.

7. PACKAGE PER PK-70873-0818.

8. PARTS MARKED WITH PART NUMBER AND DATE CODE, ON EITHER SIDE, APPROXIMATELY WHERE SHOWN.

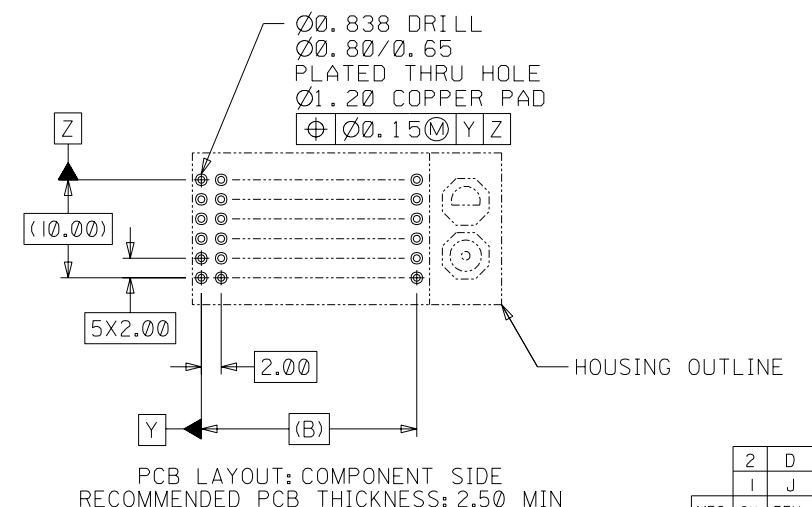
Diagram details: The diagram shows a rectangular PCB layout. Key dimensions include a total width of 11.7, a central width of 5x2.00, and a tail width of 2.00. Drill holes are specified as Ø0.838, Ø0.80/Ø.65, and Ø1.20. A copper pad is Ø0.15. The layout is marked with Z, Y, and (B) coordinates. A dashed line indicates the HOUSING OUTLINE. A note specifies a plated thru hole with a 1/2° angular tolerance.

PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 2.50 MIN

2	D
1	J

MFG.	SH.	REV.
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REVISED JDT 2000-0348 HAM 99/10/12	DIMENSIONS SHOWN (METRIC) INCH UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR ± 1/2°	▽ = 0 ▼ = 0	REVISE ONLY ON CAD SYSTEM																		
REVISED JDT 1999-0662 HAM 99/05/18	<table border="1"> <tr> <th></th> <th>INCH</th> <th>METRIC</th> </tr> <tr> <td>3 PLACE</td> <td>± N/A</td> <td>---</td> </tr> <tr> <td>2 PLACE</td> <td>± N/A</td> <td>± 0.05</td> </tr> <tr> <td>1 PLACE</td> <td>---</td> <td>± 0.10</td> </tr> </table>		INCH	METRIC	3 PLACE	± N/A	---	2 PLACE	± N/A	± 0.05	1 PLACE	---	± 0.10	TITLE SALES ASSY, HDM BACKPLANE MODULE, POLAR/GUIDE OPTION							
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REVISED JDT 1999-0476 HAM 98/12/21	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MOLEX INCORPORATED LISLE, ILL. 60532 U.S.A.	<table border="1"> <tr> <td>SHEET NO.</td> <td>DATE</td> </tr> <tr> <td>1 OF 2</td> <td>96/12/18</td> </tr> </table>	SHEET NO.	DATE	1 OF 2	96/12/18														
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		J	REVISED ECR UCP2003-2260 THOMAS 03/04/25	G	REVISED ECR UDT1999-0476 BINGHAM 98/12/21	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MOLEX INCORPORATED SHEET NO. DATE LISLE, ILL. 60532 U.S.A. 1 OF 2 96/12/18	
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						FILE NAME THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO S73644X1 MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION. DGN		DIV. SIZE DA B	

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<http://moschip.ru/get-element>

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

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